List of Publications

1. Y. Zheng, D. K.-T. Ng, Y. Wei, Y. Wang, Y. Huang, Y. Tu, C.-W. Lee, B. Liu, S.-T. Ho, “Electrically pumped heterogeneously integrated Si/III-V evanescent lasers with micro-loop mirror reflector” Applied Physics Letters, vol. 99, pp. 011103, 2011.
2. Y. Wang, Y. Wei, Y. Huang, Y. Tu, D. Ng, C.-W. Lee, Y. Zheng, B. Liu, S.-T. Ho, “Silicon/III-V laser with super-compact diffraction grating for WDM applications in electronic-photonic integrated circuits,” Optics Express, vol. 19, pp. 2006, 2011.
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